



LightningMaster
Corporation

COPPER GROUNDING PLATE LM-GP-1212 (12" X 12")



DESCRIPTION:

- 0.032 (1/32") thick high conductivity copper sheet with UL 96 Listed bonding plate
- 1/32" meets minimum thickness requirements for UL 96
- Custom sizes are available upon request

APPLICATION:

- NFPA 780 4.13.6.1 - A ground plate electrode shall have a minimum thickness of 0.032" (0.8mm) and a minimum surface area of 2 sq. ft.
- NFPA 780 4.13.6.2 - The ground plate electrode shall be buried no less than 18" below grade

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